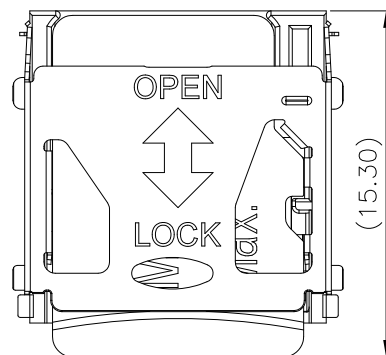
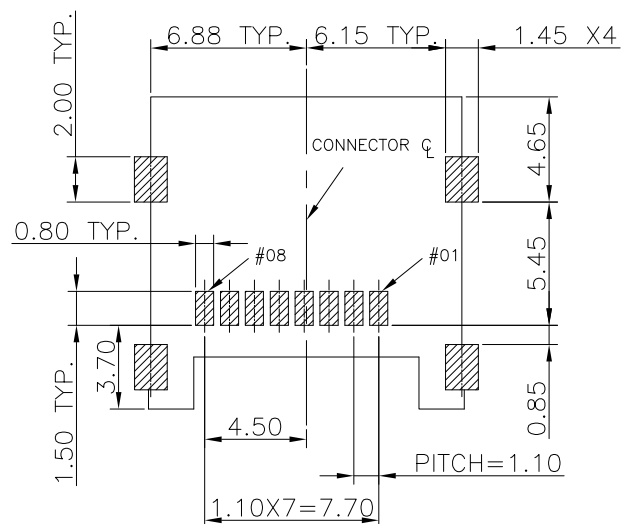
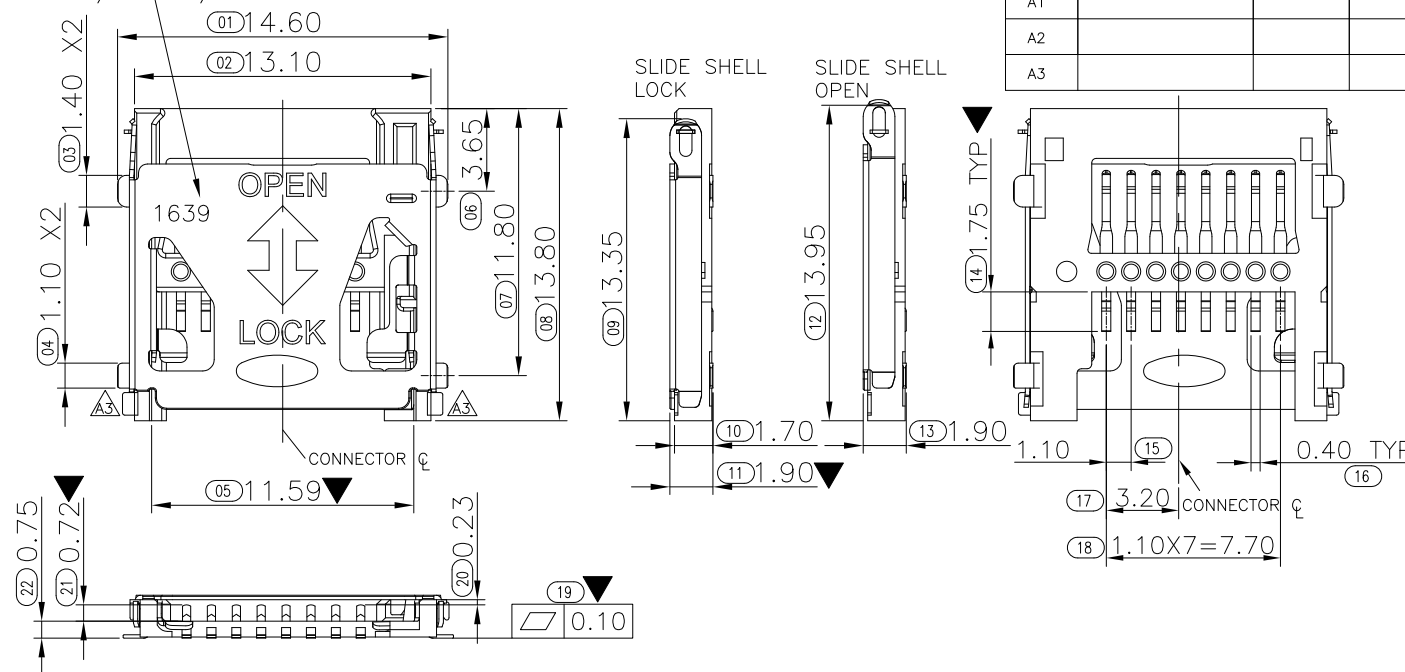


GP Component

DATE/CODE;YEAR/WEEK



PIN NO.	NAME
#01	DAT2
#02	CD/DAT3
#03	CMD
#04	VDD
#05	CLK
#06	VSS
#07	DAT0
#08	DAT1

RECOMMENDED PCB LAYOUT(TOP VIEW)

GENERAL TOLERANCES: ± 0.05

 SOLDER AREA

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2016/11/23	Phebe Su
A1			Add D/C printing	2016/11/30	Phebe Su
A2			Add the focus size mark	2017/11/16	Phebe Su
A3			Clasp widening	2018/03/29	Phebe Su

NOTES:

1. MATERIAL:
INSULATOR: HIGH TEMPERATURE THERMO PLASTIC
FLAMMABILITY RATING: UL94V-0 COLOR: BLACK
CONTACT: COPPER ALLOYS
COVER: STAINLESS STEEL
2. CONTACT AREA PLATING: GOLD 15u" OVER NI
3. SOLDER TAIL COPLANARITY MUST BE WITHIN 0.10MAX.
4. Add the focus size mark ▼

MATRIX PART NO:

Matrix
MICRO SD

01 : Push
02: Non-Push

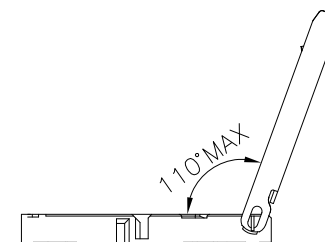
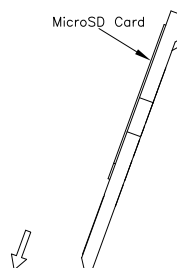
Plating
01:G/F
15:15u

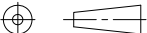
MMS-02-15-08-19-23

Series Number

Height

Pin number
06:6pin
08:8pin



NO	VARIETY	QTY	METERIAL	REMARK	
 Matrix Electronics Co.,Ltd					
TOLERANCE: X. X.X X.XX X.XXX ANGLE: ±1°		DESIGN BY : Phebe Su CHECKED BY: Vicky Hsieh APPROVED BY1: Richard Hsieh APPROVED BY2: Richard Hsieh	DATE : 2018/03/29 DATE : 2018/03/29 DATE : 2018/03/29 DATE : 2018/03/29	PART NAME: MICRO SD HINGE TYPE PART NO. MMS-02-15-08-19-23 MOLD NO. NA DRAW NO. SHEET NO.	 1 OF 1
 UNIT: mm [inch] SCALE: 1:1 SIZE: A4					